

Kyle Clocker

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Education

- 2018 – Present ▶ **Ph.D., Electrical and Computer Engineering, Oregon State University** in Analog Mixed Signal Sensor and Integrated Circuit Design.
- 2015 – 2018 ▶ **M.S., Electrical and Computer Engineering, Oregon State University** in Analog Mixed Signal Sensor and Integrated Circuit Design.
Thesis title: *CMOS-Integrated Single-Element Thermal Flow Sensors*.
- 2011 – 2015 ▶ **B.S., Electrical Engineering, University of North Texas** *Summa Cum Laude*
Department Award for Outstanding Senior Student.
College Award for Outstanding Graduating Senior.

Experience

- 2015 – Present ▶ **Oregon State University, Sensors and Integrated Microelectronics Lab** Graduate Research Assistant Advisor: Dr. Matthew L. Johnston
- Design and test of impact detection unit for eagle collisions on wind turbines
 - Design and test of a single-element flow sensor integrated in a standard 180 nm CMOS process
 - Teaching Assistant for VLSI design and analog circuit design courses
- 2017 ▶ **Intel** Graduate Technical Intern
- Test and validation integrated ESD protection for future products
- 2016 ▶ **Insitu** Electrical Hardware Intern
- Designed schematic blocks for new avionics
 - Developed and trained team on LabVIEW test platform for automated use of test equipment
 - Evaluated and simulated PCB traces for signal integrity
- 2013-2016 ▶ **Stryker Communications** Engineering Co-Op, Independent Engineering Contractor
- Design, document, and develop prototypes to evaluate new KVM solutions
 - Coordinate the manufacture of prototypes with contract manufactures
 - Test and debug prototypes and current products

Selected Publications

- Clocker, K., Sengupta, S., & Johnston, M. (2019). A fully-integrated, single-element cmos anemometer. *IEEE Sensors Letters*.
- Clocker, K., Votzke, C., Mengüç, Y., & Johnston, M. L. (2019). Compact modeling of stretchable printed liquid metal electrical interconnects. In *2019 ieee international conference on flexible and printable sensors and systems (fleps)* (pp. 1–3). IEEE.

Technical Skills

- EDA Tools ▶ Cadence Virtuoso, HSpice, Xilinx ISE, KiCad, MPLAB X, Visio
- Programming ▶ Verilog, VHDL, C, C++, MatLab, Python, L^AT_EX, Git, LabView
- Misc ▶ Micro Soldering, Oscilloscopes, High Speed PCB Layout